PRODUCT / PROCESS CHANGE INFORMATION

	1. PCI basic data	
1.1 Company	577	STMicroelectronics International N.V
1.2 PCI No.		IPD/15/9211
1.3 Title of PCI		Internal wafer epitaxy process qualification for Power Schottky Silicon Carbides Diodes
1.4 Product Category		All Silicon carbide diodes except 1200V
1.5 Issue date		2015-05-01

	2. PCI Team
2.1 Contact supplier	
2.1.1 Name	SETTLES JEFF
2.1.2 Phone	+44 1628896222
2.1.3 Email	jeff.settles@st.com
2.2 Change responsibility	
2.2.1 Product Manager	Franck DUCLOS
2.1.2 Marketing Manager	Eric PARIS
2.1.3 Quality Manager	Jean-Paul REBRASSE

	3. Change	
3.1 Category	3.2 Type of change	3.3 Manufacturing Location
Wafer Fab (Process)	(Not Defined)	ST Catania wafer fab

	4. Description of change	
	Old	New
4.1 Description	the epitaxy process is subcontrated	the epitaxy process is now done in-house
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	no	

	5. Reason / motivation for change
	Thanks to this investment, STMicroelectronics will increase its production capacity to better serve its customers through service improvement and lead time reduction, especially as volumes grow.
5.2 Customer Benefit	CAPACITY INCREASE

	6. Marking of parts / traceability of change
6.1 Description	Internal codification and QA number

	7. Timing / schedule
7.1 Date of qualification results	2015-04-20
7.2 Intended start of delivery	2015-07-20
7.3 Qualification sample available?	Upon Request

	8. Qualification / Validation		
8.1 Description			
8.2 Qualification report and qualification results	In progress	Issue Date	

	9. Attachments (additional documentations)
9211PpPrdtLst.pdf PCI - Internal wafer epitaxy.pdf	

10. Affected parts		
10. 1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
	STPSC10H065B-TR	
	STPSC10H065G-TR	
	STPSC16H065CT	
	STPSC4H065B-TR	
	STPSC4H065D	
	STPSC6H065B-TR	
	STPSC6H065G-TR	
	STPSC806D	
	STPSC8H065B-TR	

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